

## C0805C181F3GALTU

Aliases (C0805C181F3GAL7800)

SMD Comm COG SnPb, Ceramic, 180 pF, 1%, 25 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0.7 mm, 0805 / 2012



Click [here](#) for the 3D model.

### General Information

Series	SMD Comm COG SnPb
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	No
Prop 65	<b>WARNING:</b> Cancer and reproductive harm - <a href="https://www.p65warnings.ca.gov/">https://www.p65warnings.ca.gov/</a>
SCIP Number	5549986b-60cf-4a2a-afbb-4ad1d7a11dcb
Termination	Lead (SnPb)
Marking	No
Typical Component Weight	11 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
T	0.78mm +/-0.10mm
S	0.7mm MIN
B	0.5mm +/-0.25mm
Case Code (EIA / mm)	0805 / 2012

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

Specifications	
Capacitance	180 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	1%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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